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STD30NF04LT

N-channel 40 V, 0.03 Ω typ., 30 A, STripFET™ II Power MOSFET in a DPAK package

Datasheet – production data

Features

Order code	V _{DSS}	R _{DS(on)} max	I _D
STD30NF04LT	40 V	< 0.03 Ω	30 A

- 100% avalanche tested
- Logic level gate drive

Applications

Switching applications

Description

This Power MOSFET has been developed using STMicroelectronics' unique STripFET process, which is specifically designed to minimize input capacitance and gate charge. This renders the device suitable for use as primary switch in advanced high-efficiency isolated DC-DC converters for telecom and computer applications, and applications with low gate charge driving requirements.

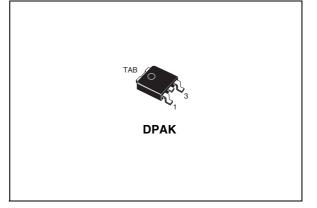


Figure 1. Internal schematic diagram

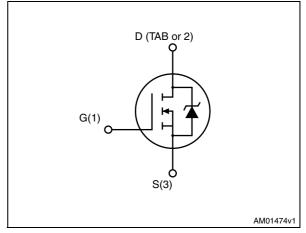


Table 1. Device summary

Order code Marking		Package	Packaging	
STD30NF04LT	STD30NF04LT D30NF04LT		Tape and reel	

This is information on a product in full production.

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1 Electrical ratings

Table 2.	Absolute	maximum	ratings
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Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage ($V_{GS} = 0$)	40	V
V _{GS}	Gate- source voltage	± 20	V
$I_D^{(1)}$	Drain current (continuous) at $T_C = 25 \ ^{\circ}C$	30	А
I _D	Drain current (continuous) at T _C = 100 °C	21	А
I _{DM}	Drain current (pulsed)	120	А
P _{tot}	Total dissipation at $T_{C} = 25 \text{ °C}$	50	W
	Derating factor	0.33	W/°C
dv/dt (2)	Peak diode recovery voltage slope	12.5	V/ns
E _{AS} ⁽³⁾	Single pulse avalanche energy	340	mJ
T _{stg}	Storage temperature		
Тj	Max. operating junction temperature	55 to 175	°C

1. Current limited by package

2. I_{SD} \leq 30 A, di/dt \leq 300 A/µs, V_{DD} \leq V_{(BR)DSS}, T_j \leq T_{JMAX}.

3. Starting T_j = 25 °C, I_D = 40 A, V_{DD} = 35 V

Table 3.	Thermal data
----------	--------------

Symbol	Symbol Parameter M		Unit
Rthj-case	Thermal resistance junction-case max	3.0	°C/W
Rthj-pcb	Thermal resistance junction-ambient max	see Section 3 on page 8	°C/W



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0$	40	-		V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = 40 V V _{DS} = 4 V, T _C = 125 °C		-	10 100	μΑ μΑ
I _{GSS} ⁽¹⁾	Gate-body leakage current (V _{DS} = 0)	$V_{GS} = \pm 20 V$		-	±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	-	2.5	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$ $V_{GS} = 5 \text{ V}, \text{ I}_{D} = 15 \text{ A}$		-	0.03 0.05	Ω Ω

Table 4. On/off states

1. Tested @ VGS = \pm 22 V at water level

Table 5.	Dynamic					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs}	Forward transconductance	V _{DS} = 15 V, I _D = 15 A	-	18		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0	-	720 220 45		pF pF pF
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD} = 20 \text{ V}, \text{ I}_{D} = 15 \text{ A}$ $R_{G} = 4.7 \Omega \text{ V}_{GS} = 10 \text{ V}$ (see <i>Figure 14</i>)	-	6 45 25 10		ns ns ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 20 \text{ V}, \text{ I}_D = 30 \text{ A},$ $V_{GS} = 10 \text{ V}$ (see <i>Figure 15</i>)	-	17 3.8 4	25	nC nC nC

Table 5. Dynamic



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} I _{SDM} ⁽¹⁾	Source-drain current Source-drain current (pulsed)		-		30 120	A A
$V_{SD}^{(2)}$	Forward on voltage	I _{SD} = 30 A, V _{GS} = 0	-		1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 30 \text{ A}, \text{ di/dt} = 100 \text{ A/µs},$ $V_{DD} = 20 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see <i>Figure 16</i>)	-	30 60 4		ns nC A

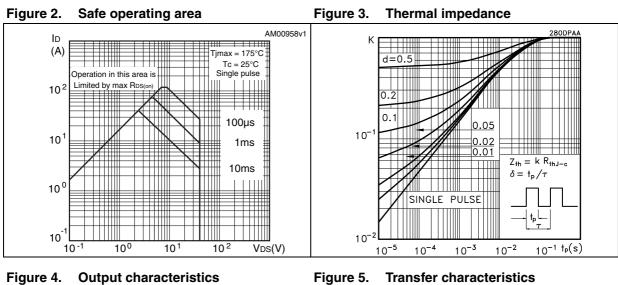
Table 6.Source drain diode

1. Pulse width limited by safe operating area.

2. Starting T_j = 25 °C, I_D = 40 A, V_{DD} = 35 V



2.1 Electrical characteristics (curves)



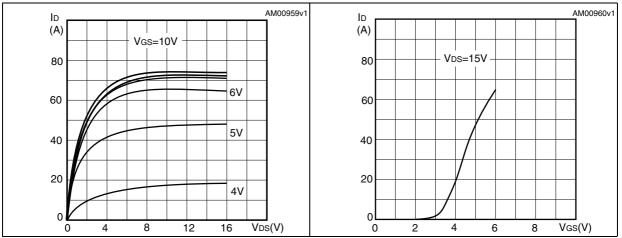
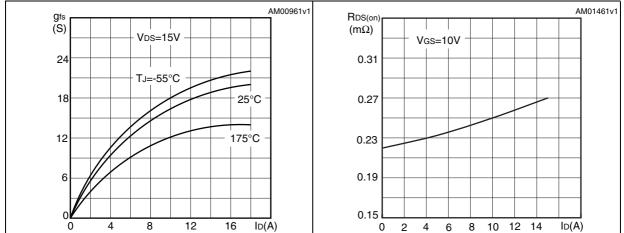


Figure 6. Transconductance

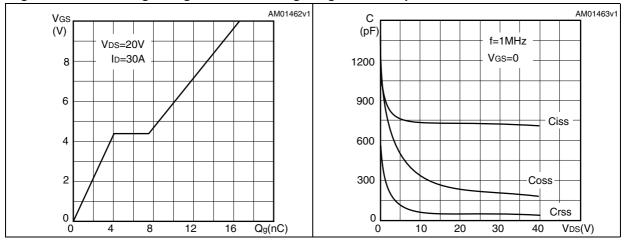
Figure 7. Static drain-source on-resistance



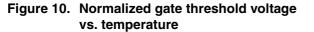
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Gate charge vs. gate-source voltage Figure 9. Figure 8. **Capacitance variations**





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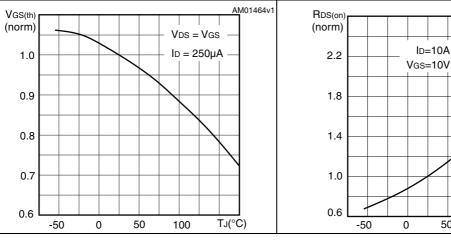


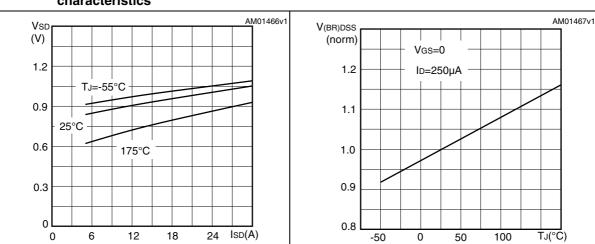
Figure 12. Source-drain diode forward characteristics



50

100

(^{°C})UT



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Figure 14. Switching times test circuit for

resistive load

Test circuit Package mechanical data 3

3.3 2200 RL μF μF Vdd VD 0 Vgs **★** D.U.T. RG Pw AM01468v1

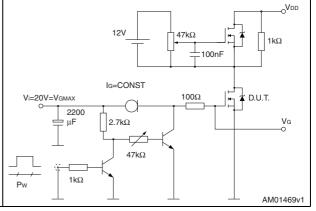
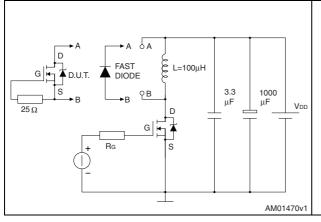


Figure 15. Gate charge test circuit

Figure 16. Test circuit for inductive load switching and diode recovery times





VD

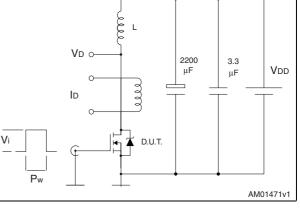
ldм

lр

V(BR)DSS



Figure 17. Unclamped Inductive load test



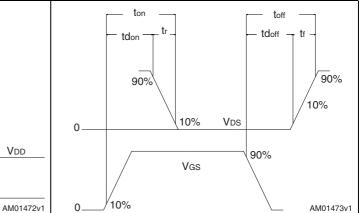


Figure 19. Switching time waveform



Vdd

4 Package mechanical data

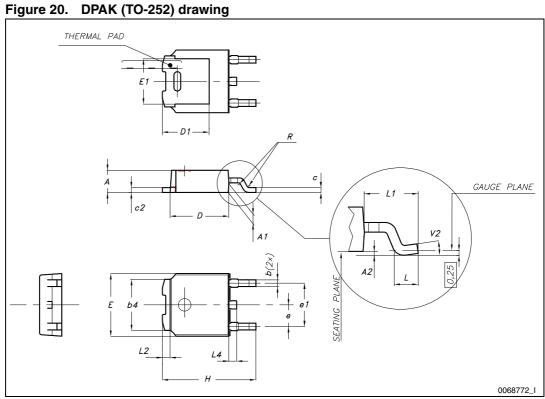
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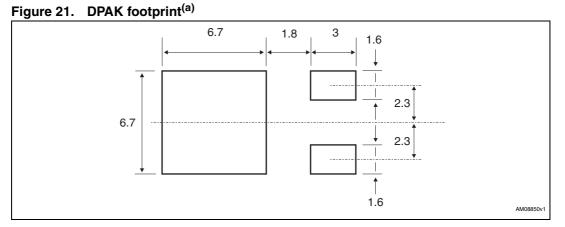


Table 7.	DPAK (TO-252) mechanical data

Dim	· · · ·	mm	
Dim.	Min.	Тур.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
е		2.28	
e1	4.40		4.60
Н	9.35		10.10
L	1		
L1		2.80	
L2		0.80	
L4	0.60		1
R		0.20	
V2	0°		8°







a. All dimensions are in millimeters.



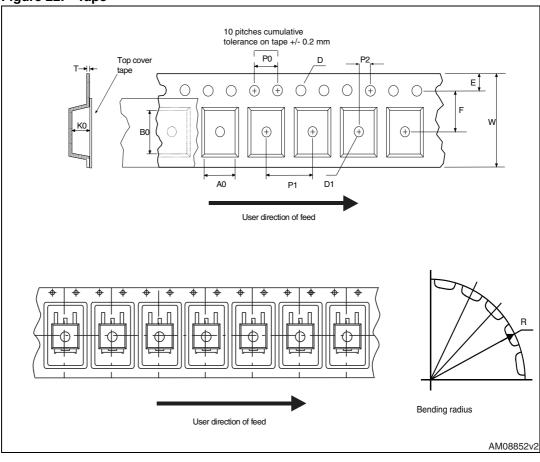
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5 Packaging mechanical data

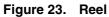
Таре				Reel		
Dim	mm		Dim	mm		
Dim. —	Min.	Max.	— Dim.	Min.	Max.	
A0	6.8	7	Α		330	
B0	10.4	10.6	В	1.5		
B1		12.1	С	12.8	13.2	
D	1.5	1.6	D	20.2		
D1	1.5		G	16.4	18.4	
E	1.65	1.85	N	50		
F	7.4	7.6	Т		22.4	
K0	2.55	2.75				
P0	3.9	4.1		Base qty. 2500		
P1	7.9	8.1		Bulk qty.	2500	
P2	1.9	2.1				
R	40					
Т	0.25	0.35				
W	15.7	16.3				

Table 8. DPAK (TO-252) tape and reel mechanical data

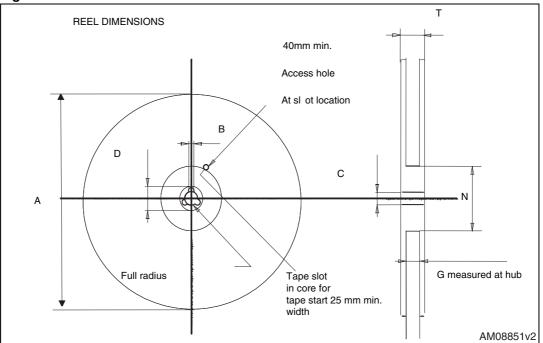








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6 Revision history

Table 9.Document revision history

Date	Revision	Changes
23-Nov-2012	1	First release.



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